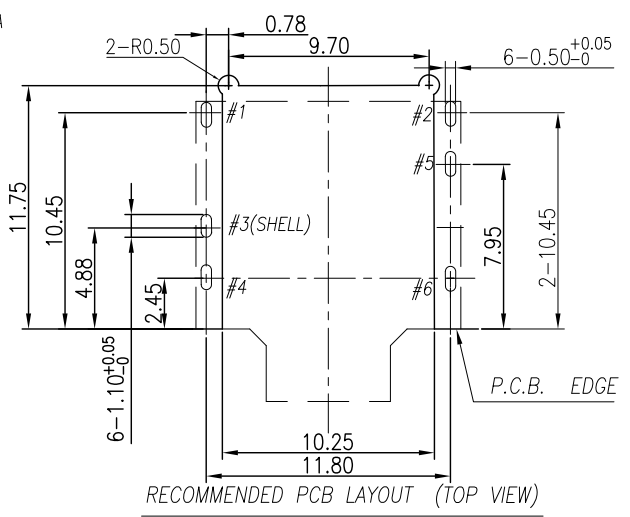
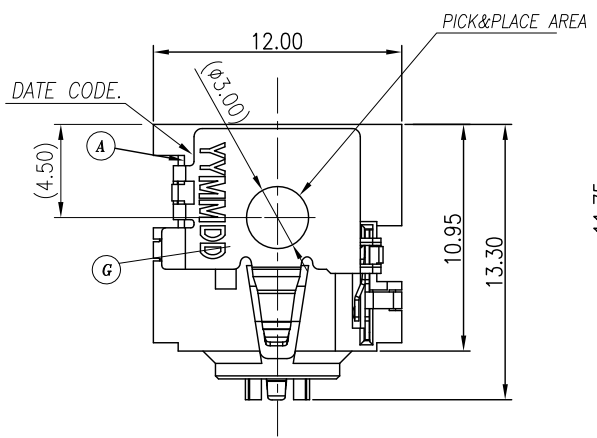


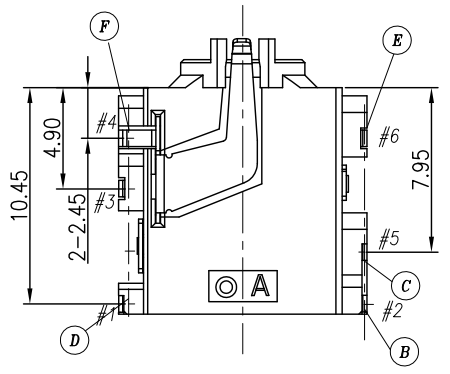
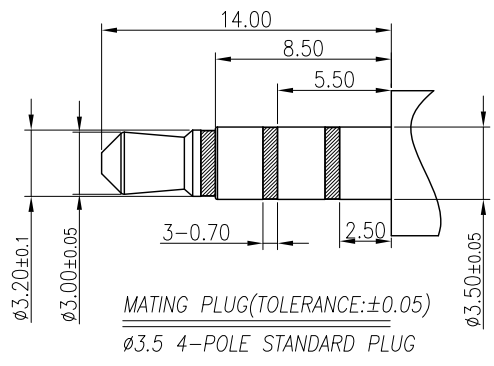
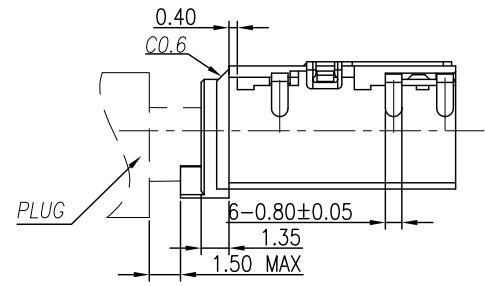
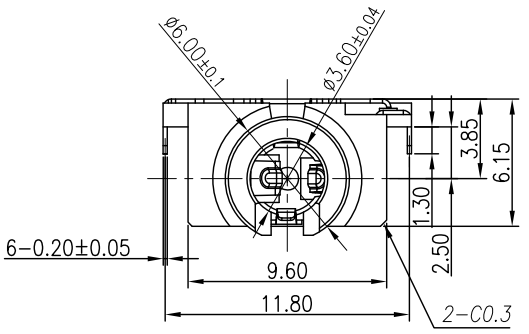
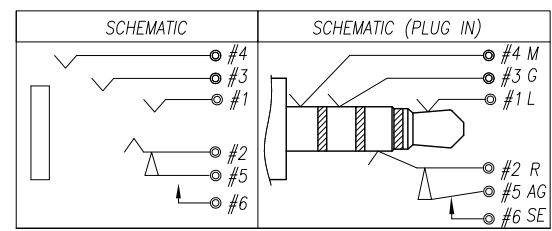
REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PDR NO: T121119-2A	Aaron	2013.03.19



SPECIFICATIONS:

- INSULATION RESISTANCE BETWEEN ANY ADJACENT OPEN CIRCUIT TERMINAL SHELL NOT BE LESS THAN 100MΩ MEASURED BY 500 VDC .
- CONTACT RESISTANCE :50mΩ MAX.
- INSULATION VOLTAGE WITHSTAND :  
500V AC FOR ONE MINUTE.
- LIFE TEST : 5,000 CYCLES MIN. (NON-LOAD)
- INSERTION FORCE :0.3 - 3.0Kg.
- WITHDRAWAL FORCE :0.3 - 3.0Kg.
- PACKAGING : TAPE & REEL.
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT: Ⓢ
- HALOGEN FREE PRODUCT IDENTIFICATION LOGO ON PACKING: Ⓢ

RECOMMENDED PCB LAYOUT (TOP VIEW)  
(TOLERANCE:±0.05)



G	SHIELDING	1	COPPER ALLOY, 0.2t	NICKEL PLATING 50u".
F	EARTH	1	COPPER ALLOY, 0.2t	GOLD FLASH ON CONTACT, AND SOLDER TAIL AREA, ALL OVER 60u" NICKEL PLATING.
E	MAKE	1	COPPER ALLOY, 0.2t	
D	TIP	1	COPPER ALLOY, 0.2t	
C	TRANSFER	1	COPPER ALLOY, 0.2t	
B	RING SPRING &SEPARATOR	1	COPPER ALLOY, 0.2t HIGH TEMP.THERMOPLASTIC	BLACK
A	BODY	1	HIGH TEMP.THERMOPLASTIC UL 94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES

Singatron Enterprise Co., Ltd.  
信音企業股份有限公司

DECIMALS:	ANGLES:	TITLE	3.5Ø PHONE JACK		
.X :±0.25	X. :±3°	DWN	Aaron	PART NO.2SJ3086-008111F	
.XX :±0.15	.X :±2°	CHKD	Bruce	SCALE: 4:1	UNIT: mm
.XXX :±0.05	.XX :±1°	APVD	Lussen	SIZE: A3	SHEET: 1 OF 1

CUSTOMER COPY